74LVT244B; 74LVTH244B

3.3 V octal buffer/line driver; 3-state

Rev. 5 — 12 February 2021

Product data sheet

1. General description

The 74LVT244B; 74LVTH244B is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables (1 \overline{OE} and 2 \overline{OE}), each controlling four of the 3-state outputs. A HIGH on n \overline{OE} causes the outputs to assume a high-impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs

2. Features and benefits

- · Octal bus interface
- 3-state buffers
- Speed upgrade of 74LVT244A
- Wide supply voltage range from 2.7 to 3.6 V
- · BiCMOS high speed and output drive
- Output capability: +64 mA and -32 mA
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Input and output interface capability to systems at 5 V supply
- · Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- Live insertion and extraction permitted
- I_{OFF} circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standards
 - JESD8C (2.7 V to 3.6 V)
- ESD protection:
 - HBM EIA/JESD22-A114-C exceeds 2000 V
 - MM EIA/JESD22-A115-A 200 V
- Specified from -40 °C to +85 °C

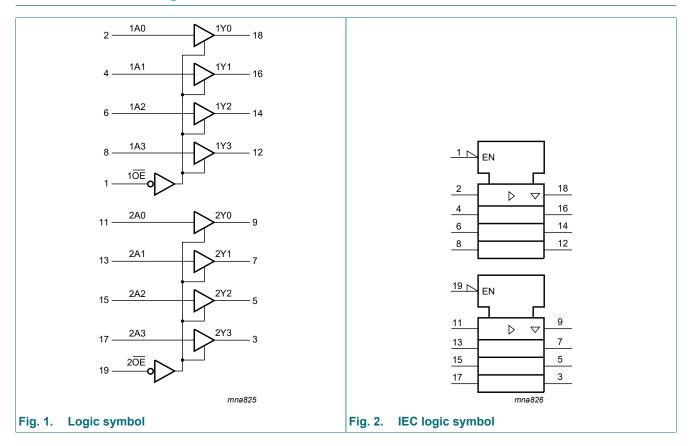
3. Ordering information

Table 1. Ordering information

Type number	Package	Package									
	Temperature range	Name	Description	Version							
74LVT244BD	-40 °C to +85 °C	SO20	plastic small outline package; 20 leads;	SOT163-1							
74LVTH244BD			body width 7.5 mm								
74LVT244BDB	-40 °C to +85 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1							
74LVT244BPW	-40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1							
74LVTH244BPW			body width 4.4 mm								

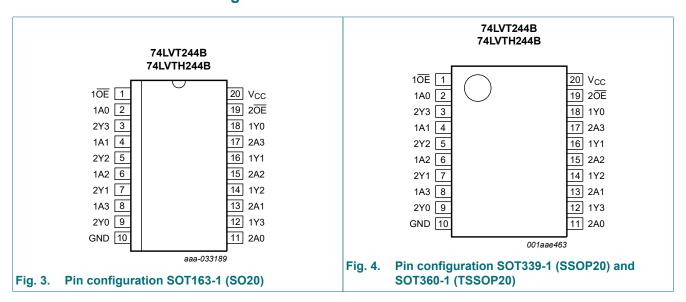


4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1 OE , 2 OE	1, 19	output enable input (active low)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2Y0, 2Y1, 2Y2, 2Y3	9, 7, 5, 3	data output
GND	10	ground (0 V)
2A0, 2A1, 2A2, 2A3	11, 13, 15, 17	data input
1Y0, 1Y1, 1Y2, 1Y3	18, 16, 14, 12	data output
V _{CC}	20	supply voltage

6. Functional description

Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ Z = high-impedance \ OFF-state.$

	Input	Output
nŌĒ	nAn	nYn
L	L	L
L	Н	Н
Н	X	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	[1	-0.5	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state [1	-0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Io	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-64	-	mA
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[2	-	150	°C
P _{tot}	total power dissipation	T _{amb} = -40 to +85 °C	-	500	mW

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

^[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.7	-	3.6	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-32	-	-	mA
I _{OL}	LOW-level output current	none	-	-	32	mA
		current duty cycle ≤ 50 %; f _i ≥ 1 kHz	-	-	64	mA
T _{amb}	ambient temperature	in free-air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	outputs enabled	-	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -4	40 °C to +85 °C			'		
V _{IK}	input clamping voltage	V _{CC} = 2.7 V; I _{IK} = -18 mA	-1.2	-0.9	-	V
V _{IH}	HIGH-level input voltage		2.0	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.8	V
V _{OH}	HIGH-level output voltage	V _{CC} = 2.7 V; I _{OH} = -100 μA	V _{CC} - 2.0	V _{CC} - 2.1	-	V
		V _{CC} = 2.7 V; I _{OH} = -8 mA	2.4	2.5	-	V
		V _{CC} = 3.0 V; I _{OH} = -32 mA	2.0	2.2	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 2.7 V; I _{OL} = 100 μA	-	0.1	0.2	V
		V _{CC} = 2.7 V; I _{OL} = 24 mA	-	0.3	0.5	V
		V _{CC} = 3.0 V; I _{OL} = 16 mA	-	0.25	0.4	V
		V _{CC} = 3.0 V; I _{OL} = 32 mA	-	0.3	0.5	V
		V _{CC} = 3.0 V; I _{OL} = 64 mA	-	0.4	0.55	V
l _l i	input leakage current	all input pins				
		V _{CC} = 0 V or 3.6 V; V _I = 5.5 V	-	0.1	10	μΑ
		control pins				
		V_{CC} = 3.6 V; V_{I} = V_{CC} or GND	-1	±0.1	1	μΑ
		data pins [2]				
		V _{CC} = 3.6 V; V _I = V _{CC}	-	0.1	1	μΑ
		V _{CC} = 3.6 V; V _I = 0 V	-5	-1	-	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ V to } 4.5 \text{ V}$	-100	1	+100	μA
I _{BHL}	bus hold LOW current	V _{CC} = 3 V; V _I = 0.8 V	75	130	-	μΑ
I _{BHH}	bus hold HIGH current	V _{CC} = 3 V; V _I = 2.0 V	-	-140	-75	μA
I _{BHLO}	bus hold LOW overdrive current	$_{CC} = 3.6 \text{ V}; V_1 = 0 \text{ V to } 3.6 \text{ V}$ [3] 500		-	-	μΑ
Івнно	bus hold HIGH overdrive current	$V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$	V _{CC} = 3.6 V; V _I = 0 V to 3.6 V			μΑ
I _{EX}	external current	nYn output in HIGH-state when V _O > V _{CC} ; V _O = 5.5 V; V _{CC} = 3.3 V	-	60	125	μΑ

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
I _{O(pu/pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_I = \text{GND or } V_{CC}; n\overline{\text{OE}} = \text{don't care}$	[4]	-100	±1	+100	μA
l _{OZ}	OFF-state output current	V _{CC} = 3.6 V; V _I = V _{IH} or V _{IL}					
		V _O = 3.0 V		-	1	5	μΑ
		V _O = 0.5 V		-5	-1	-	μA
I _{CC} si	supply current	$V_{CC} = 3.6 \text{ V}; V_{I} = \text{GND or } V_{CC}; I_{O} = 0 \text{ A}$					
		output HIGH		-	0.13	0.19	mA
		output LOW		-	2	5	mA
		outputs disabled	[5]	-	0.13	0.19	mA
Δl _{CC}	additional supply current	per input pin; V_{CC} = 3.0 V to 3.6 V; one input at V_{CC} - 0.6 V and other inputs at V_{CC} or GND	[6]	-	0.1	0.2	mA
Cı	input capacitance	V _I = 0 V or 3.0 V		-	4	-	pF
Co	output capacitance	outputs disabled; V _O = 0 V or 3.0 V		-	8	-	pF

- [1] Typical values are measured at T_{amb} = 25 °C.
- [2] Unused pins at V_{CC} or GND.
- This is the bus hold overdrive current required to force the input to the opposite logic state.
- [4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 3.3 V ± 0.3 V a transition time of 100 μ s is permitted. This parameter is valid for T_{amb} = 25 °C only.
- [5] I_{CC} is measured with outputs pulled to V_{CC} or GND.
- [6] This is the increase in supply current for each input at V_{CC} 0.6 V.

10. Dynamic characteristics

Table 7. Dynamic characteristics

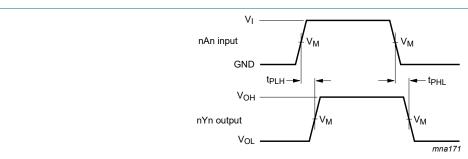
Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -4	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$					
t _{PLH}		nAn to nYn; see Fig. 5				
	propagation delay	V _{CC} = 2.7 V	-	-	3.8	ns
		V _{CC} = 3.0 V to 3.6 V	1.1	1.9	3.5	ns
t _{PHL}		nAn to nYn; see Fig. 5				
		V _{CC} = 2.7 V	-	-	3.6	ns
		V _{CC} = 3.0 V to 3.6 V	1.3	2.0	3.3	ns
t _{PZH}		nOE to nYn; see Fig. 6				
		V _{CC} = 2.7 V	-	-	5.3	ns
tp_LH LOW to HIGH	V _{CC} = 3.0 V to 3.6 V	1.1	2.8	4.5	ns	
t _{PZL}		nOE to nYn; see Fig. 6				
	propagation delay	V _{CC} = 2.7 V	-	-	4.9	ns
		V _{CC} = 3.0 V to 3.6 V	1.4	2.3	4.4	ns

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
t _{PHZ}	HIGH to OFF-state	nOE to nYn; see Fig. 6				
	propagation delay	V _{CC} = 2.7 V	-	-	4.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.9	2.9	4.4	ns
·		nOE to nYn; see Fig. 6				
	propagation delay	V _{CC} = 2.7 V	-	-	4.4	ns
		V _{CC} = 3.0 V to 3.6 V	1.8	2.5	4.4	ns

^[1] Typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

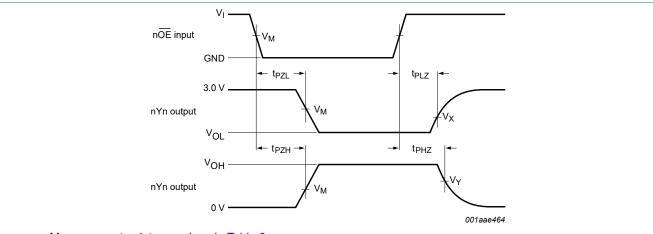
10.1. Waveforms and test circuit



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 5. Propagation delay input (nAn) to output (nYn)



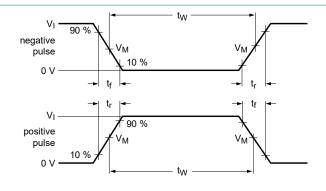
Measurement points are given in Table 8.

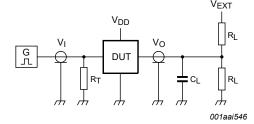
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 6. 3-state output enable and disable times

Table 8. Measurement points

Input	Output	ıtput							
V_{M}	V _M	V _X	V_{Y}						
1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V						





Test data is given in Table 9.

Definitions test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = Test voltage for switching times.

Fig. 7. Test circuit for measuring switching times

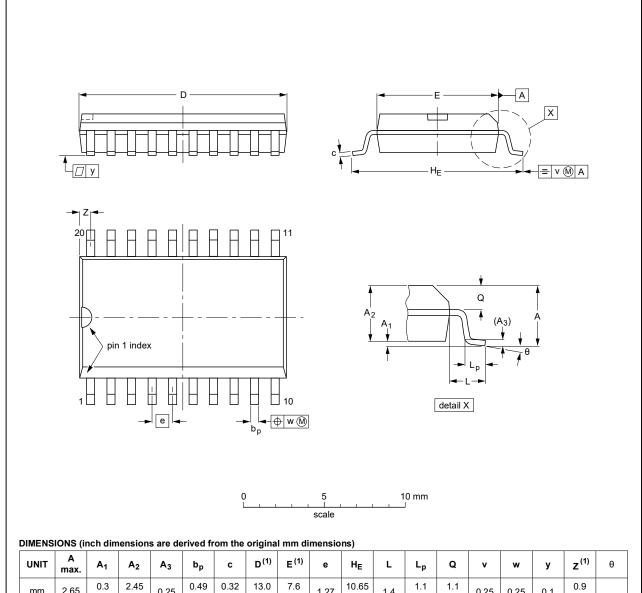
Table 9. Test data

Input			Load V _{EXT}					
V _I	fi	t _W	t _r , t _f	CL	R_L	t _{PHZ} , t _{PZH}	t _{PLZ} , t _{PZL}	t _{PLH} , t _{PHL}
2.7 V	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V	open

11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE		
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				99-12-27 03-02-19

Fig. 8. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

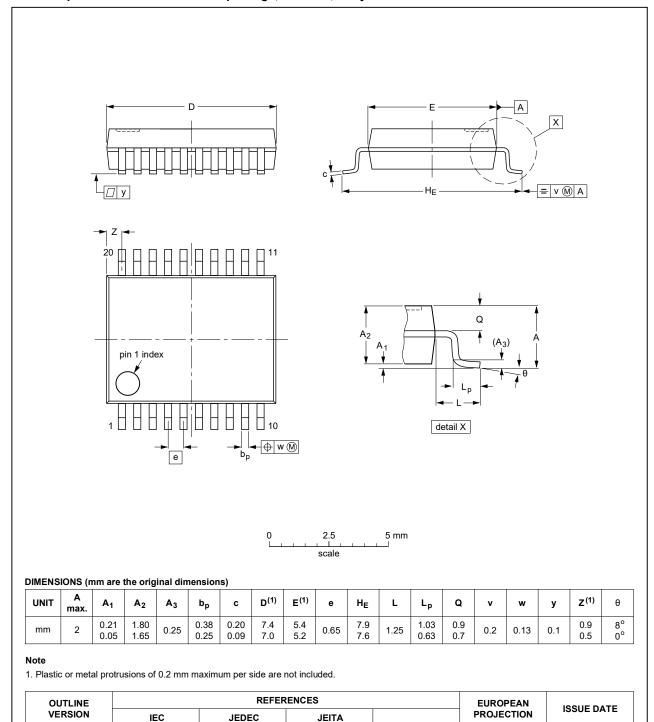


Fig. 9. Package outline SOT339-1 (SSOP20)

99-12-27

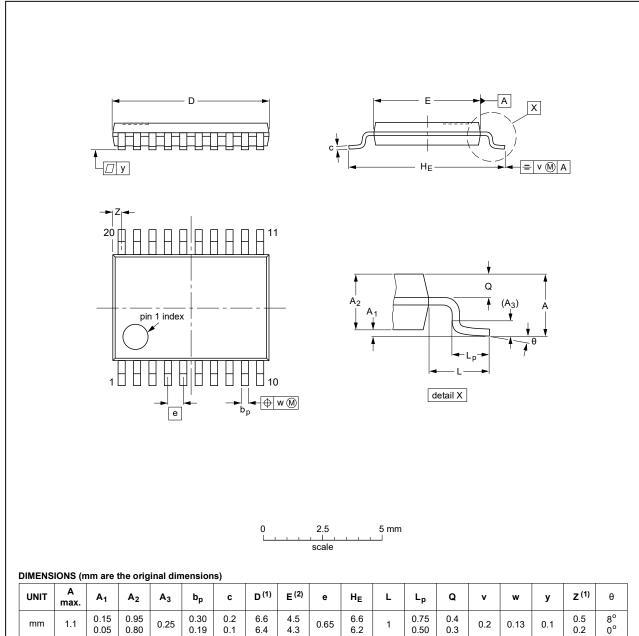
03-02-19

MO-150

SOT339-1

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE		
		IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT360-1		MO-153				99-12-27 03-02-19

Fig. 10. Package outline SOT360-1 (TSSOP20)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74LVT_LVTH244B v.5	20210212	Product data sheet	-	74LVT_LVTH244B v.4				
Modifications:	1 .	74LVTH244BDB (SOT3 d <u>Section 2</u> updated.	39-1 / SSOP20) rem	oved.				
74LVT_LVTH244B v.4	20170614	Product data sheet	-	74LVT_LVTH244B v.3				
Modifications:	Nexperia.	The format of this data sheet has been redesigned to comply with the identity guidelines of						
74LVT_LVTH244B v.3	20060303	Product data sheet	-	74LVT244B v.2				
Modifications:	 The format of this data sheet has been redesigned to comply with the new presentation an information standard of Philips Semiconductors. Section 3: Added type numbers 74LVTH244BD, 74LVTH244BDB and 74LVTH244BPW. 							
74LVT244B v.2	20030919	Product specification	-	74LVT244B v.1				
74LVT244B v.1	19981101	Product specification	-	-				

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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